IAP20 Rec'd TOTATO 12 JAN 2006

SHIGA7.036APC PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant

: Masuda et al.

Appl. No.

: Unknown

Filed

: Herewith

For

: POSITIVE PHOTORESIST

COMPOSITION AND METHOD OF FORMING RESIST PATTERN

Examiner

: Unknown

Group Art Unit

: Unknown

PRELIMINARY AMENDMENT

Mail Stop Amendment

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

Preliminary to examination on the merits, please amend the above-captioned U.S. National Phase Application as follows:

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 3 of this paper.

Remarks/Arguments begin on page 5 of this paper.